

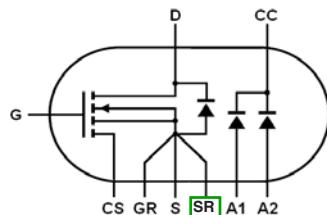
Polar3™
Power MOSFET
Current & Temperature Sensing

MMIX1T132N50P3

V_{DSS} = 500V
I_{D25} = 63A
R_{DS(on)} ≤ 43mΩ

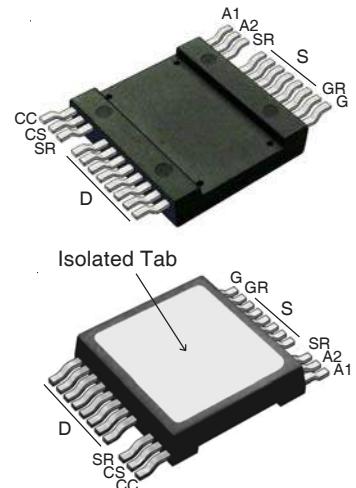
(Electrically Isolated Tab)

N-Channel Enhancement Mode
Avalanche Rated



Symbol	Test Conditions	Maximum Ratings	
V _{DSS}	T _J = 25°C to 150°C	500	V
V _{DGR}	T _J = 25°C to 150°C, R _{GS} = 1MΩ	500	V
V _{GSS}	Continuous	±30	V
V _{GSM}	Transient	±40	V
I _{D25}	T _C = 25°C	63	A
I _{DM}	T _C = 25°C, Pulse Width Limited by T _{JM}	330	A
I _A	T _C = 25°C	66	A
E _{AS}	T _C = 25°C	2	J
dv/dt	I _S ≤ I _{DM} , V _{DD} ≤ V _{DSS} , T _J ≤ 150°C	35	V/ns
P _D	T _C = 25°C	520	W
T _J		-55 ... +150	°C
T _{JM}		150	°C
T _{stg}		-55 ... +150	°C
T _L	Maximum Lead Temperature for Soldering	300	°C
T _{SOLD}	Plastic Body for 10s	260	°C
V _{ISOL}	50/60 Hz, 1 Minute	2500	V~
F _c	Mounting Force	50..200 / 11..45	N/lb.
Weight		8	g

Symbol	Test Conditions (T _J = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV _{DSS}	V _{GS} = 0V, I _D = 3mA	500		V
V _{GS(th)}	V _{DS} = V _{GS} , I _D = 8mA	3.0		V
I _{GSS}	V _{GS} = ±30V, V _{DS} = 0V			±200 nA
I _{DSS}	V _{DS} = V _{DSS} , V _{GS} = 0V Note 2, T _J = 125°C			50 μA 3 mA
R _{DS(on)}	V _{GS} = 10V, I _D = 66A, Note 1			43 mΩ



G - Gate
CS - Current Sense
GR - Gate Return
S - Source
SR - Sense Current Return
A1 - Anode 1
A2 - Anode 2
CC - Common Cathode
D - Drain

Features

- Silicon Chip on Direct-Copper-Bond Substrate
 - High Power Dissipation
 - Isolated Mounting Surface
 - 2500V~ Electrical Isolation
- Avalanche Rated
- Low Package Inductance
- Current Mirror for MOSFET Source & Sensing
- Integrated Diodes for Sensing MOSFET Temperature
- Low R_{DS(on)}

Advantages

- Easy to Mount
- Space Savings

Applications

- DC-DC Converters
- AC-DC Converters
- PFC
- Connect / Disconnect Load
- Inrush Current Control

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$ Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	$V_{DS} = 10\text{V}$, $I_D = 66\text{A}$, Note 1	68	110	S
C_{iss}		18.6		nF
C_{oss}		1710		pF
C_{rss}		12		pF
R_{GI}	Gate Input Resistance	1.16		Ω
$t_{d(on)}$	Resistive Switching Times $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 66\text{A}$ $R_G = 1\Omega$ (External)	42		ns
t_r		19		ns
$t_{d(off)}$		90		ns
t_f		15		ns
$Q_{g(on)}$	$V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 66\text{A}$	267		nC
Q_{gs}		95		nC
Q_{gd}		63		nC
R_{thJC}			0.05	$^\circ\text{C}/\text{W}$
R_{thCS}			30	$^\circ\text{C}/\text{W}$
R_{thJA}				$^\circ\text{C}/\text{W}$

Source-Drain Diode

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$ Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I_s	$V_{GS} = 0\text{V}$		132	A
I_{SM}	Repetitive, Pulse Width Limited by T_{JM}		530	A
V_{SD}	$I_F = 100\text{A}$, $V_{GS} = 0\text{V}$, Note 1		1.5	V
t_{rr}	$I_F = 66\text{A}$, $-di/dt = 100\text{A}/\mu\text{s}$ $V_R = 100\text{V}$, $V_{GS} = 0\text{V}$	600		ns
Q_{RM}		12		μC
I_{RM}		40		A

Notes:

1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.
2. Part must be heatsunk for high-temp I_{DSS} measurement.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

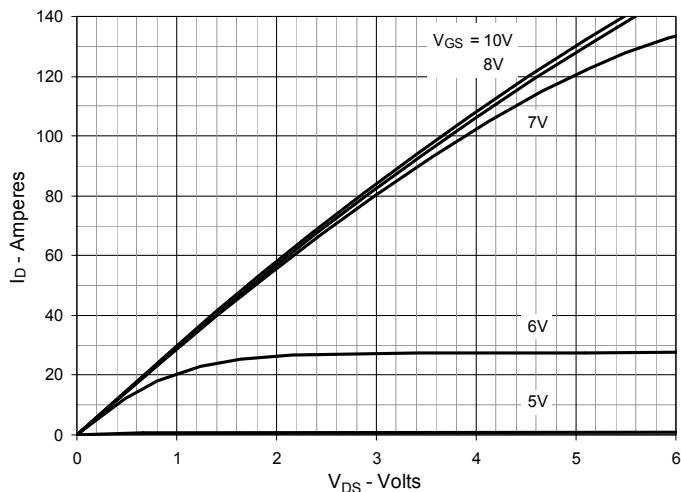
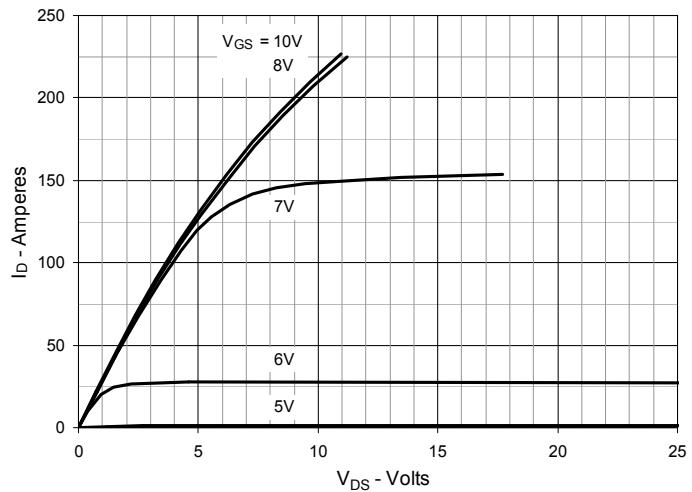
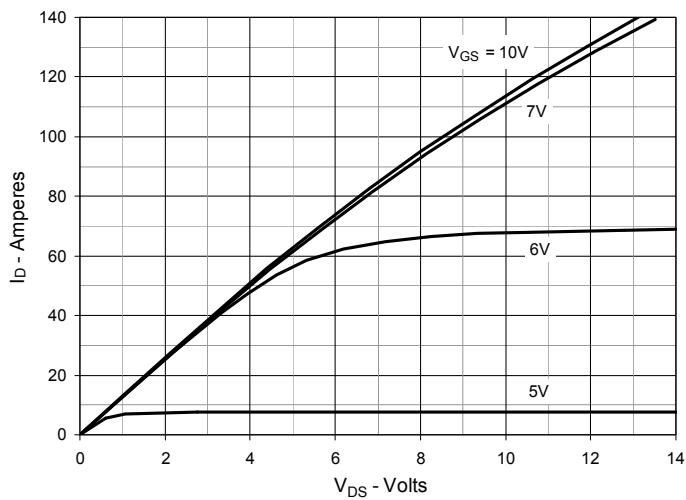
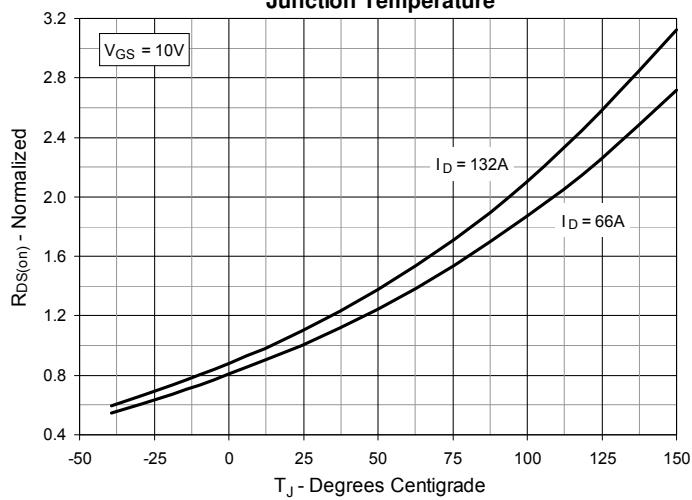
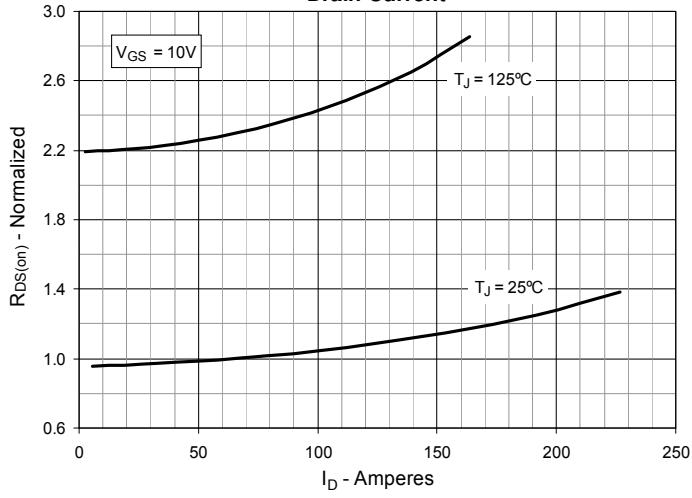
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$ Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$ Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$ Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 66\text{A}$ Value vs. Junction TemperatureFig. 5. $R_{DS(on)}$ Normalized to $I_D = 66\text{A}$ Value vs. Drain Current

Fig. 6. Maximum Drain Current vs. Case Temperature

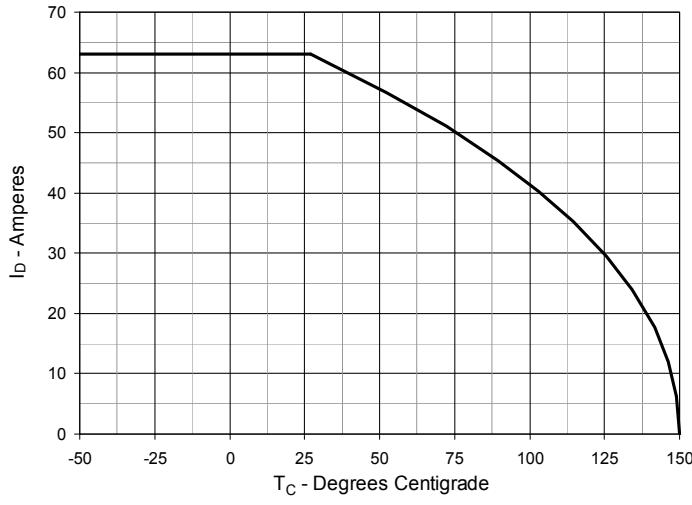


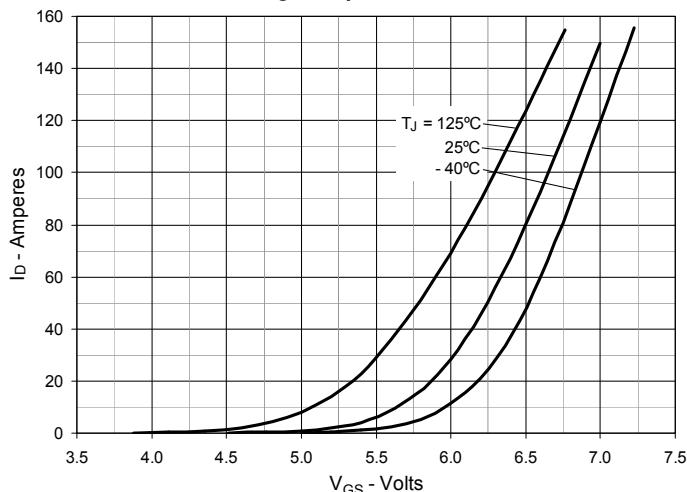
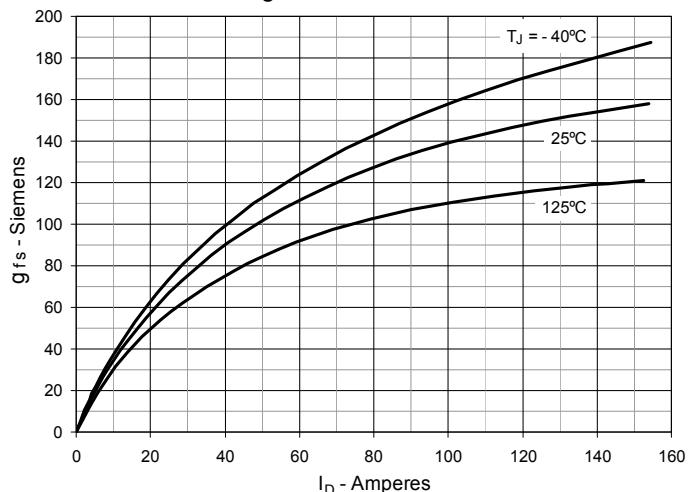
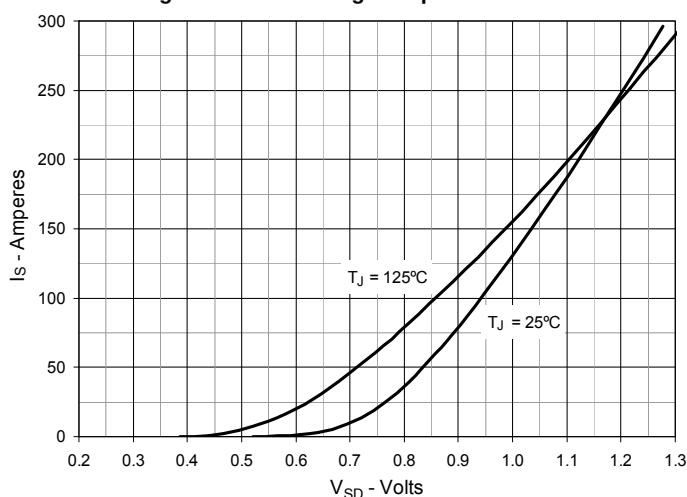
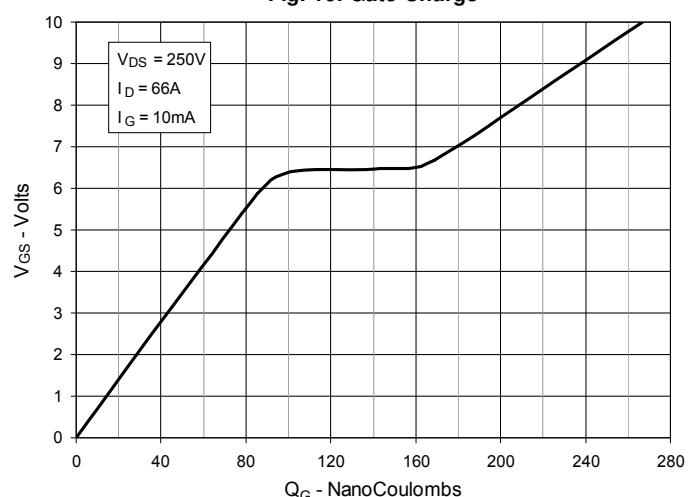
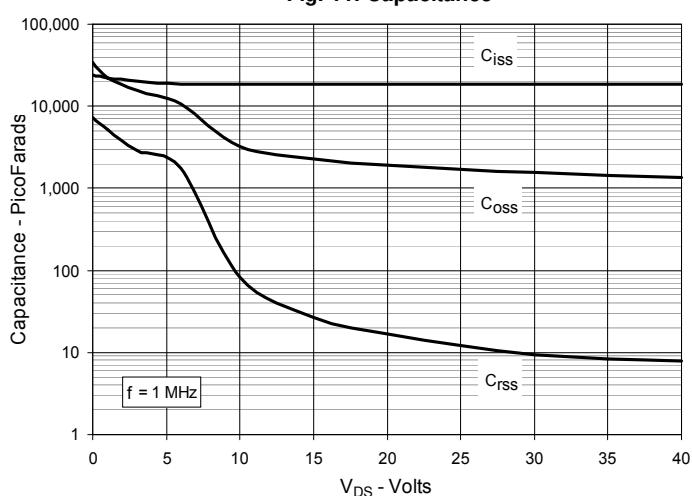
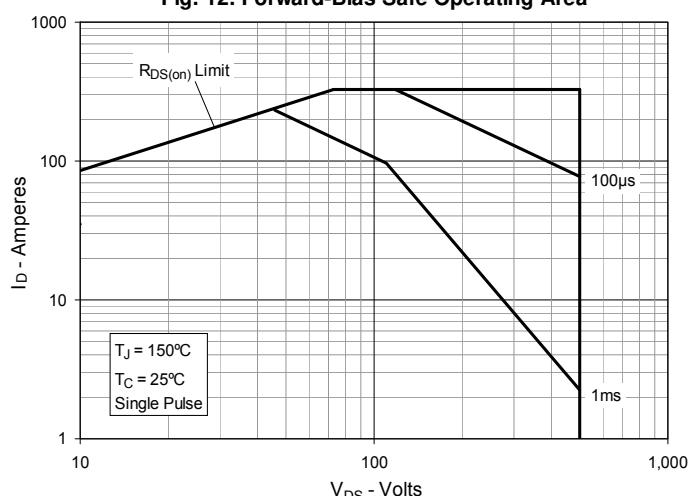
Fig. 7. Input Admittance**Fig. 8. Transconductance****Fig. 9. Forward Voltage Drop of Intrinsic Diode****Fig. 10. Gate Charge****Fig. 11. Capacitance****Fig. 12. Forward-Bias Safe Operating Area**

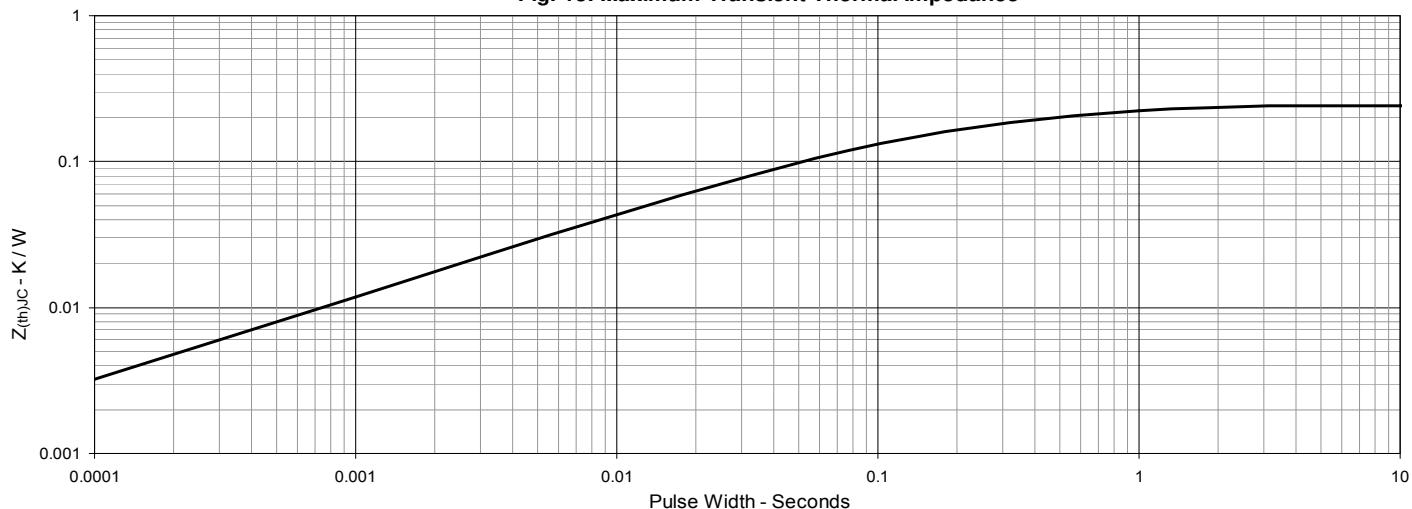
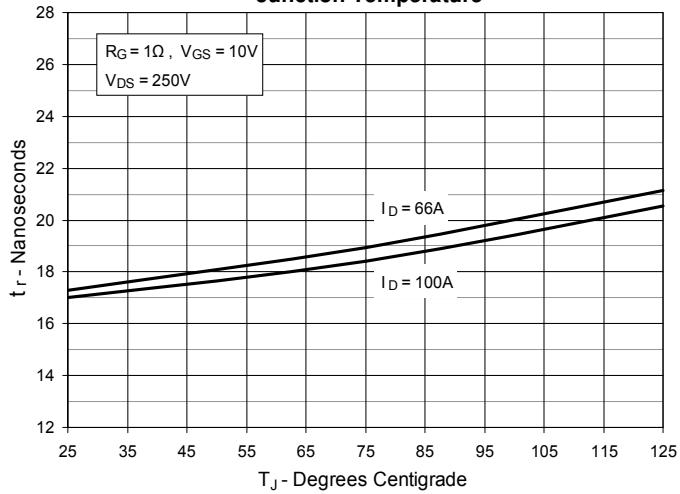
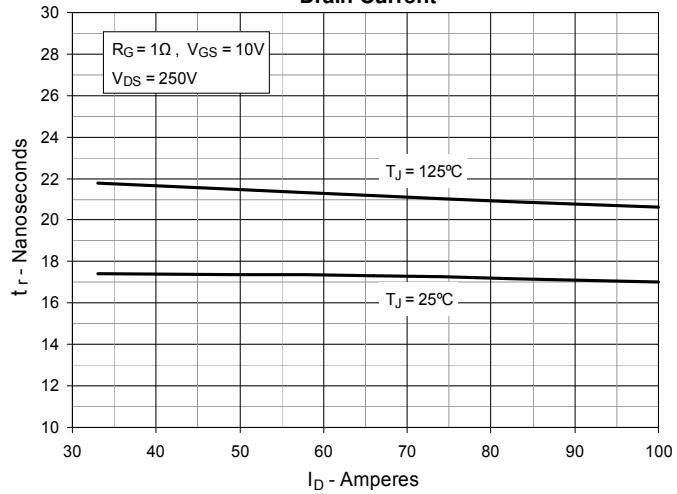
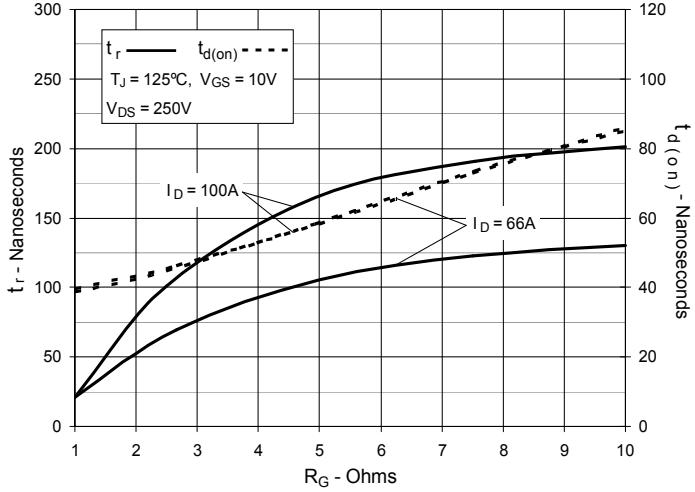
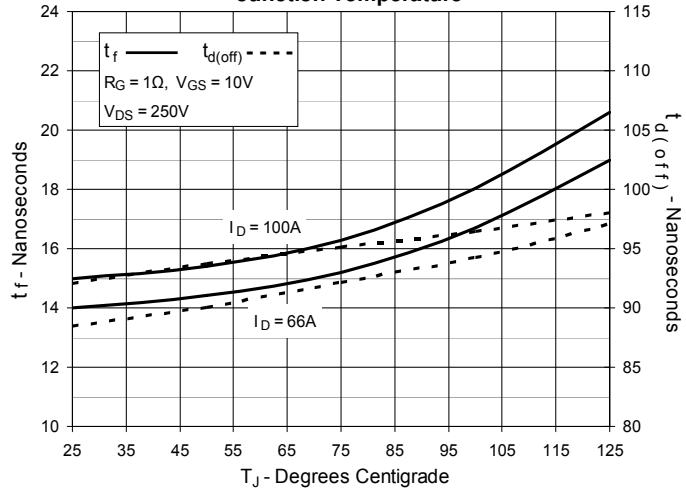
Fig. 13. Maximum Transient Thermal Impedance**Fig. 14. Resistive Turn-on Rise Time vs. Junction Temperature****Fig. 15. Resistive Turn-on Rise Time vs. Drain Current****Fig. 16. Resistive Turn-on Switching Times vs. Gate Resistance****Fig. 17. Resistive Turn-off Switching Times vs. Junction Temperature**

Fig. 18. Resistive Turn-off Switching Times vs. Drain Current

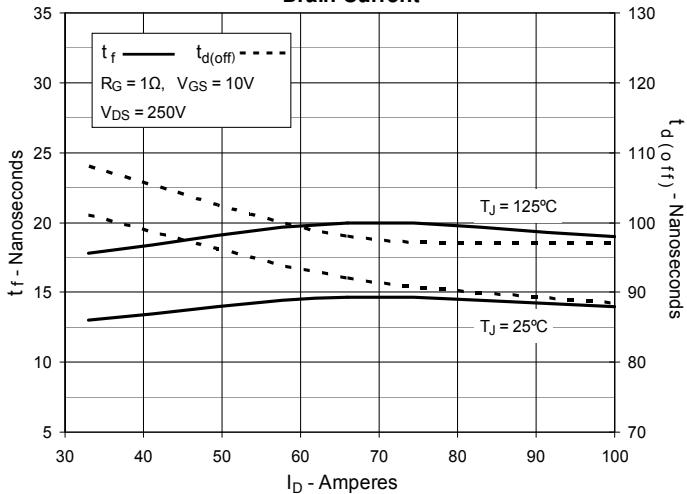


Fig. 20. Forward Current vs. Forward Voltage of Temp. Sensing Diode

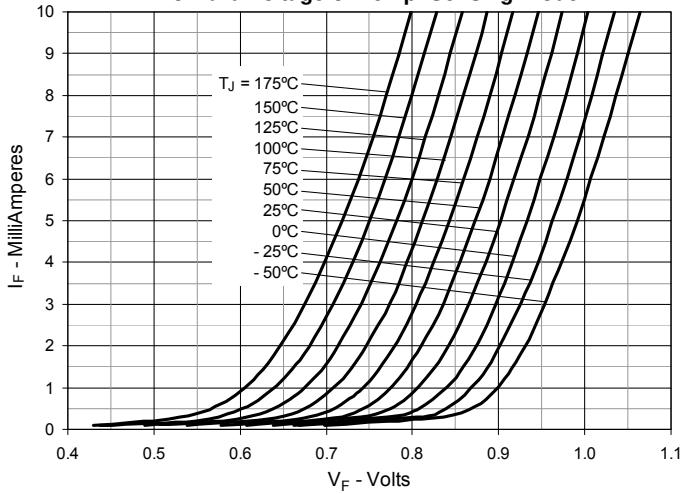


Fig. 22. Delta Forward Voltage of Temp. Sensing Diode vs. Junction Temperature

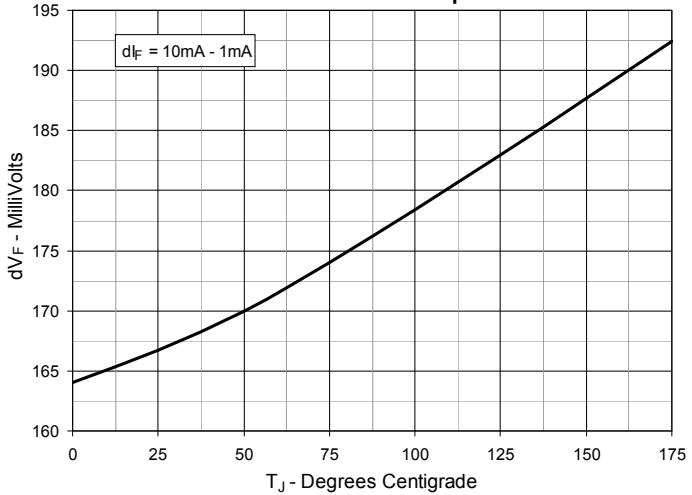


Fig. 19. Resistive Turn-off Switching Times vs. Gate Resistance

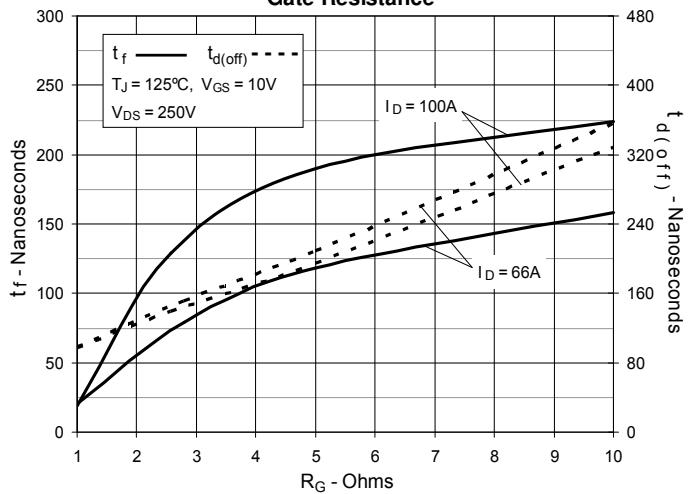


Fig. 21. Forward Voltage of Temp. Sensing Diode vs. Junction Temperature

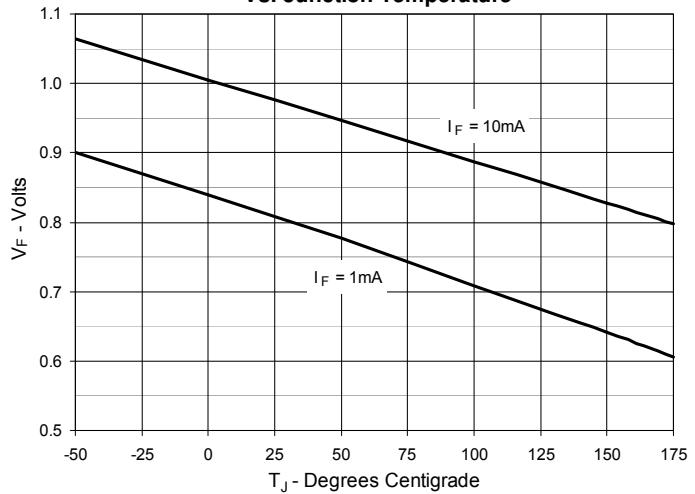
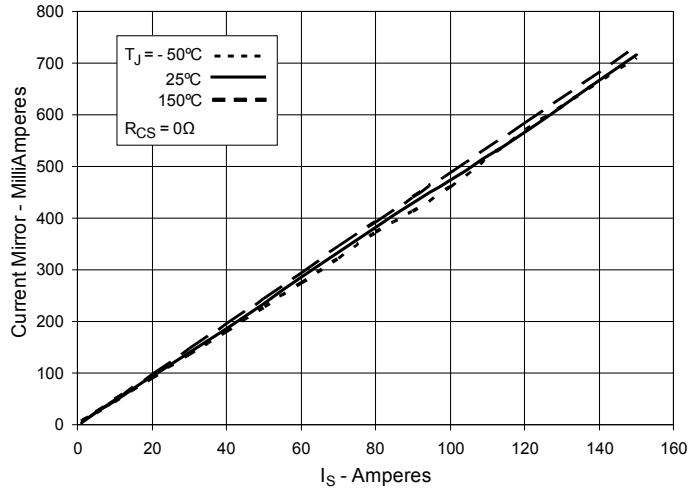
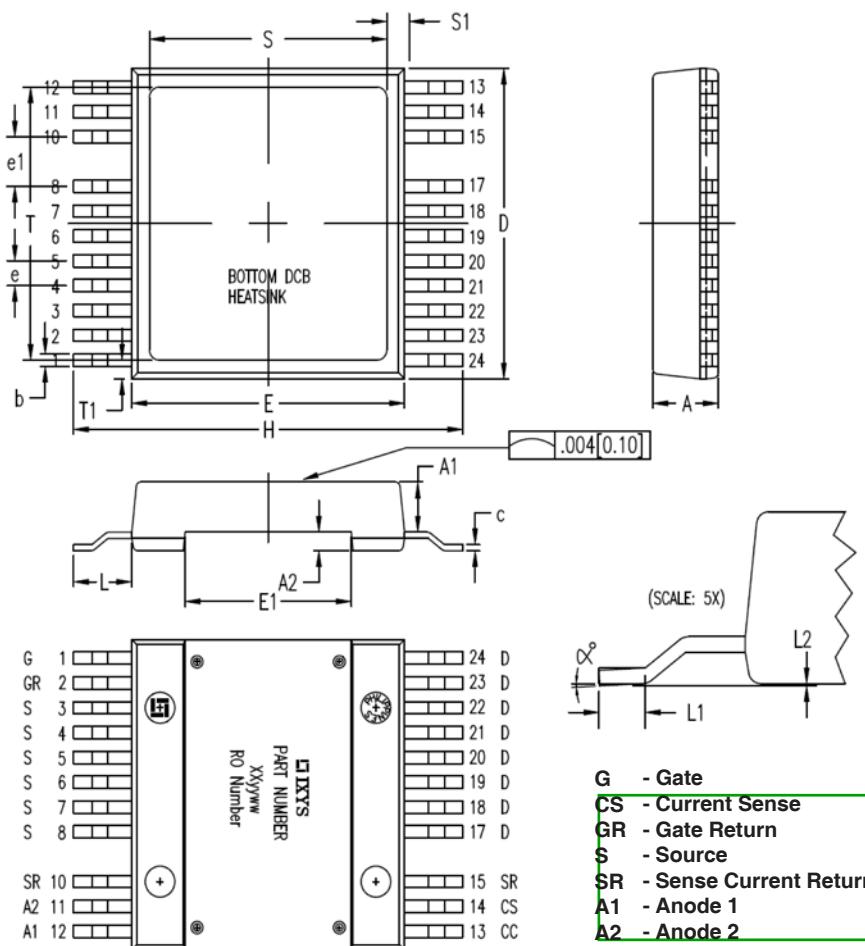


Fig. 23. Current Mirror vs. Source Current





SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.209	.224	5.30	5.70
A1	.154	.161	3.90	4.10
A2	.055	.063	1.40	1.60
b	.035	.045	0.90	1.15
c	.018	.026	0.45	0.65
D	.976	.994	24.80	25.25
E	.898	.915	22.80	23.25
E1	.543	.559	13.80	14.20
e	.079 BSC		2.00 BSC	
e1	.157 BSC		4.00 BSC	
H	1.272	1.311	32.30	33.30
L	.181	.209	4.60	5.30
L1	.051	.067	1.30	1.70
L2	.000	.006	0.00	0.15
S	.748	.807	19.00	20.50
S1	.039	.079	1.00	2.00
T	.826	.886	21.00	22.50
T1	.039	.079	1.00	2.00
ꝝ	0	4°	0	4°

G - Gate
CS - Current Sense
GR - Gate Return
S - Source
SR - Sense Current Return
A1 - Anode 1
A2 - Anode 2
CC - Common Cathode
D - Drain



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